

SANYO

No. 3491A

LC66404A, 66406A, 66408A

**4K/6K/8K-BYTE ROM-CONTAINED
SINGLE-CHIP 4-BIT MICROCOMPUTER
FOR CONTROL-ORIENTED APPLICATIONS**

General Description

The LC66404A, 66406A, 66408A are 42-pin package type CMOS 4-bit single-chip microcomputers. They contain a ROM, a RAM, I/O ports, a dual 8-bit serial interface, A/D converter input, a 12-bit timer, an 8-bit timer, and provide 8 interrupt sources with 8 vector addresses.

Features

- (1) On-chip 4K-byte/6K-byte/8K-byte ROM, 512x4-bit RAM
- (2) Instruction set with 128 instructions common with the LC665XX series
- (3) I/O ports ----- 36 pins
- (4) 8-bit serial interface ----- 2 lines (16-bit cascade connection available)
- (5) Minimum instruction cycle time ----- 0.92 μ s (4.3MHz external clock input mode)
- (6) Powerful timer function and prescaler
12-bit timer-used interval timer, event counter, pulse width measurement, burst pulse output
8-bit timer-used interval timer, event counter, PWM output, burst pulse output
12-bit prescaler-used time base function
- (7) A/D converter
6-bit, 6-channel
- (8) Powerful 8-source 8-vector interrupt function
External interrupt: 3 sources, 3 vector addresses
Internal interrupt: 5 sources, 5 vector addresses (timer: 2 sources, serial I/O: 2 sources, prescaler)
- (9) Flexible I/O function
A/D converter input, 20mA drive output, 15V breakdown voltage, pull-up/open drain selectable by option
- (10) Runaway detection function (option)
- (11) 8-bit input/output function
- (12) HALT/HOLD mode-used power-down function
- (13) Package: DIP42S, QFP48E (QIP48E)
- (14) Evaluation LSI: LC66599 (evaluation chip) + EVA850/800-TB6640X, LC66E408 (microcomputer with EPROM)

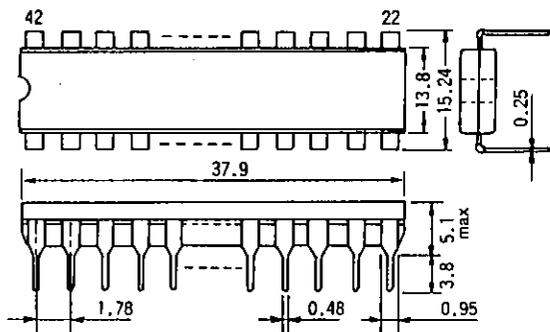
Series Lineup

Type No.	Pins	ROM capacity	RAM capacity	Package	Remark
LC66304A/306A/308A	42,48	4K/6K/8KB	512W	DIP42S, QFP48E	Available
LC66354A/356A/358A	42,48	4K/6K/8KB	512W	DIP42S, QFP48E	Available
LC66354S/356S/358S	44	4K/6K/8KB	512W	QFP44M	Under development
LC66E308	42,48	EPROM 8KB	512W	DIP42S, QFP48E with window	Available
LC66P308	42,48	OTPROM 8KB	512W	DIP42S, QFP48E	Available
LC66404A/406A/408A	42,48	4K/6K/8KB	512W	DIP42S, QFP48E	Available
LC66E408	42,48	EPROM 8KB	512W	DIP42S, QFP48E with window	Available
LC66P408	42,48	OTPROM 8KB	512W	DIP42S, QFP48E	Available
LC66506B/508B/512B/516B	64	6K/8K/12K/16KB	512W	DIP64S, QFP64A	Available
LC66556A/558A/562A/566A	64	6K/8K/12K/16KB	512W	DIP64S, QFP64E	Available
LC66354B/356B/358B	42,48	4K/6K/8KB	512W	DIP42S, QFP48E	Available
LC66556B/558B	64	6K/8K	512W	DIP64S, QFP64E	Under development
LC66562B/566B	64	12K/16KB	512W	DIP64S, QFP64E	Available
LC66E516	64	EPROM 16KB	512W	DIP64S, QFP64E with window	Available
LC66P516	64	OTPROM 16KB	512W	DIP64S, QFP64E	Available

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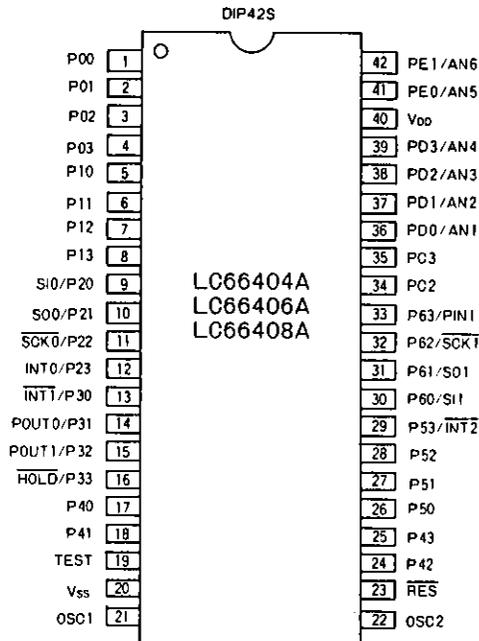
Package Dimensions 3025B

(unit : mm)



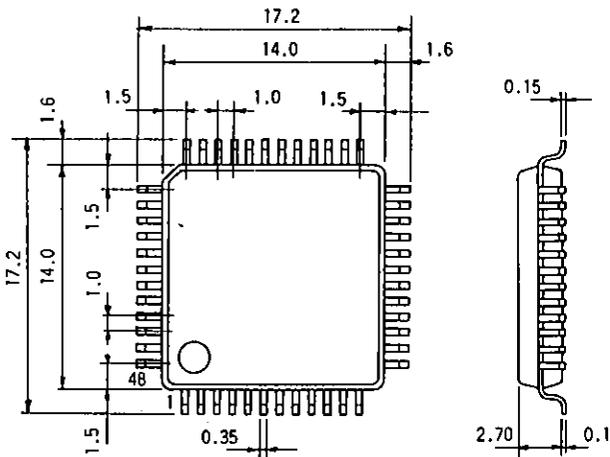
SANYO : DIP42S

Pin Assignment



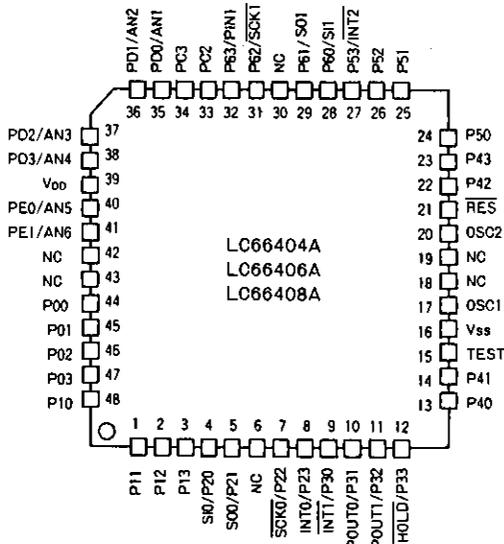
Package Dimensions 3156

(unit : mm)



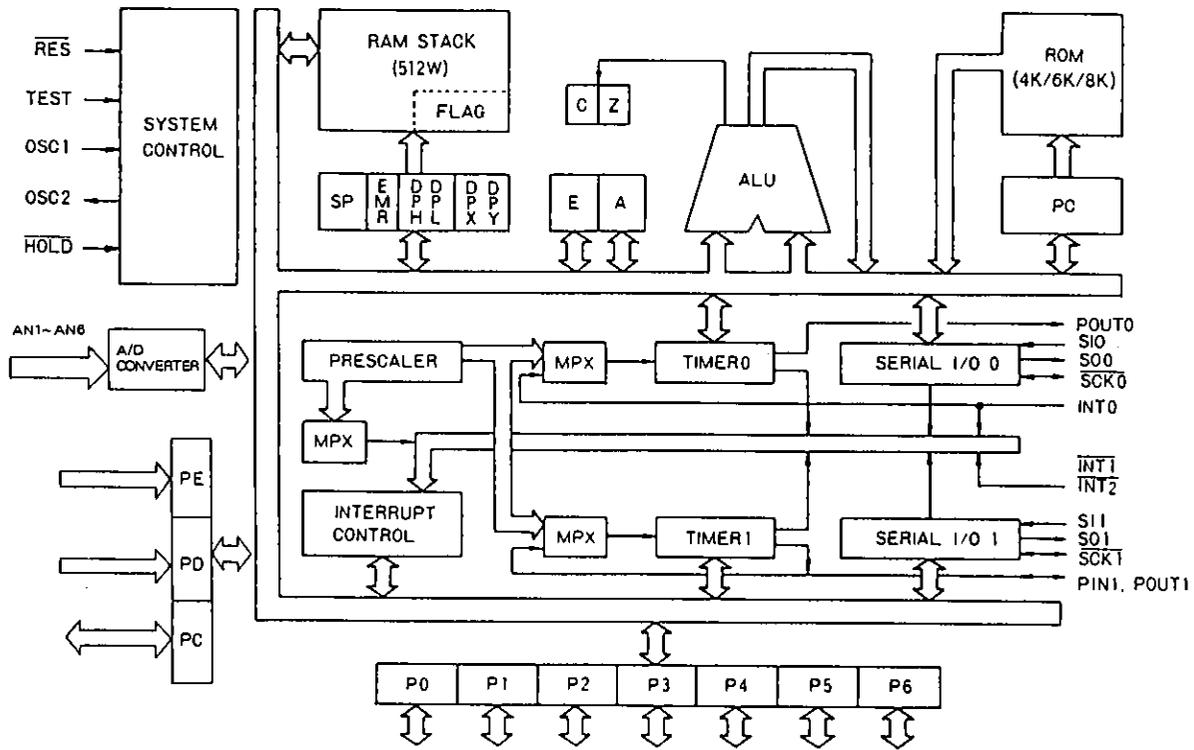
SANYO : QFP48E (QIP48E)

Pin Assignment



Note) Reflow soldering is recommended for QFP (QIP) packages.
Please consult your local representative for information on solder-bath immersion of the device.

System Block Diagram



Pin Description

Pin Name	I/O	Functions	Output Driver Type	Option	During Reset
P00 P01 P02 P03	I/O	Input/output common port P00 to P03 • 4-bit and single-bit input/output • P00 to P03: Provided with HALT mode control function	• Pch: Pu MOS type • Nch: Sink medium current type	• With Pu MOS or Nch OD output • Output level during reset	H or L (option)
P10 P11 P12 P13	I/O	Input/output common port P10 to P13 • 4-bit and single-bit input/output	• Pch: Pu MOS type • Nch: Sink medium current type	• With Pu MOS or Nch OD output • Output level during reset	H or L (option)
P20/SIO P21/SO0 P22/SCK0 P23/INT0	I/O	Input/output common port P20 to P23 • 4-bit and single-bit input/output • P20: Common with serial input SIO • P21: Common with serial output SO0 • P22: Common with serial clock SCK0 • P23: Common with INT0 interrupt and timer 0-used event count, pulse width measurement input	• Pch: CMOS type • Nch: Sink medium current type • +15V breakdown voltage at Nch OD configuration	• CMOS or Nch OD output	H

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Pin Name	I/O	Functions	Output Driver Type	Option	During Reset
P30/ $\overline{\text{INT1}}$ P31/POUT0 P32/POUT1	I/O	Input/output common port P30 to P32 <ul style="list-style-type: none"> • 3-bit and single-bit Input/output • P30: Common with $\overline{\text{INT1}}$ interrupt request • P31: Common with burst pulse output from timer 0 • P32: Common with burst pulse output, PWM output from timer 1 	<ul style="list-style-type: none"> • Pch: CMOS type • Nch: Sink medium current type • +15 breakdown voltage at Nch OD configuration 	<ul style="list-style-type: none"> • CMOS or Nch OD output 	H
P33/ $\overline{\text{HOLD}}$	I	HOLD mode control Input <ul style="list-style-type: none"> • The HOLD mode is entered by executing the HOLD instruction at $\overline{\text{HOLD}}=\text{L}$. • The CPU is restarted by setting the $\overline{\text{HOLD}}$ to H level at the HOLD mode. • Usable as input port P33 with P30 to P32 • Even if the $\overline{\text{RES}}$ is brought to L level when the P33/$\overline{\text{HOLD}}$ is at L level, the CPU is not reset. So this pin must be H level when VDD has risen to a point where the CPU can operate properly. 			
P40 P41 P42 P43	I/O	Input/output port P40 to P43 <ul style="list-style-type: none"> • 4-bit and single-bit input/output • 8-bit input/output with P50 to P53 • 8-bit output of ROM data with P50 to P53 	<ul style="list-style-type: none"> • Pch: Pu MOS type • Nch: Sink medium current type • +15 breakdown voltage at Nch OD configuration 	<ul style="list-style-type: none"> • With Pu MOS or Nch OD output 	H
P50 P51 P52 P53/ $\overline{\text{INT2}}$	I/O	Input/output port P50 to P53 <ul style="list-style-type: none"> • 4-bit and single-bit Input/output • 8-bit input/output with P40 to P43 • 8-bit output of ROM data with P40 to P43 • P53: Common with $\overline{\text{INT2}}$ interrupt request 	<ul style="list-style-type: none"> • Pch: Pu MOS type • Nch: Sink medium current type • +15 breakdown voltage at Nch OD configuration 	<ul style="list-style-type: none"> • With Pu MOS or Nch OD output 	H

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Pin Name	I/O	Functions	Output Driver Type	Option	During Reset
P60/SI1 P61/SO1 P62/SCK1 P63/PIN1	I/O	Input/output common port P60 to P63 <ul style="list-style-type: none"> • 4-bit and single-bit Input/output • P60: Common with serial input SI1 • P61: Common with serial output SO1 • P62: Common with serial clock SCK1 • P63: Common with event counter input of timer 1 	<ul style="list-style-type: none"> • Pch: CMOS type • Nch: Sink medium current type • +15V breakdown voltage at Nch OD configuration 	• CMOS or Nch OD output	H
PC2 PC3	I/O	Input/output common port PC2 to PC3 <ul style="list-style-type: none"> • 2-bit and single-bit input/output 	<ul style="list-style-type: none"> • Pch: CMOS type • Nch: Sink medium current type 	• CMOS or Nch OD output	H
PD0/AN1 PD1/AN2 PD2/AN3 PD3/AN4	I	Input-only port PD0 to PD3 <ul style="list-style-type: none"> • The AD input is software-selectable. • AN1: AD converter input channel 1 • AN2: AD converter input channel 2 • AN3: AD converter input channel 3 • AN4: AD converter input channel 4 			Normal input
PE0/AN5 PE1/AN6	I	Input-only port <ul style="list-style-type: none"> • The AD input is software-selectable. 			Normal input
OSC1 OSC2	I O	Pins for externally connecting R, C or a ceramic resonator for system clock generation. For the external clock mode, the OSC2 pin is left open and the OSC1 pin is used for input.		• Ceramic resonator OSC, RC OSC, or external clock	
\overline{RES}	I	System reset input pin <ul style="list-style-type: none"> • When the \overline{RES} is brought to L level at P33/HOLD=H, the CPU is initialized. 			
TEST	I	CPU test pin Connected to VSS at the operating mode			
VDD VSS		Power supply pins			

Remarks: Output with Pu MOS ----- Output with pull-up MOS transistor
 CMOS output ----- Complementary output
 OD output ----- Open drain output

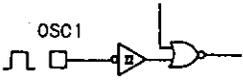
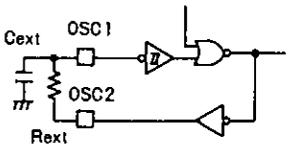
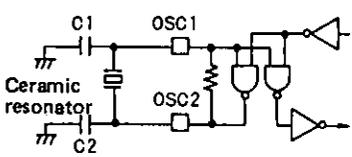
User Options

(1) Options of ports 0, 1 output level during reset

For input/output ports 0, 1 either of the following two output levels may be selected in a group of 4 bits during reset by option

Option Name	Conditions, etc.
1. Output during reset: "H" level	All of 4 bits of ports 0, 1
2. Output during reset: "L" level	All of 4 bits of ports 0, 1

(2) Oscillator Circuit Options

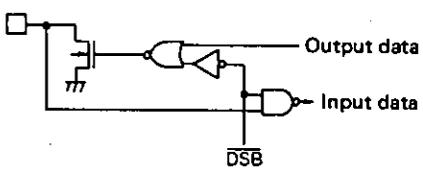
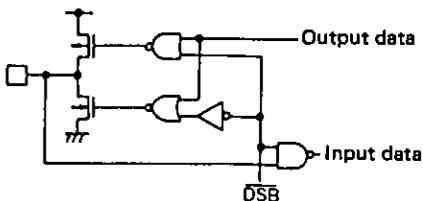
Option Name	Circuit	Conditions, etc.
1. External clock		• Input: Schmitt type
2. 2-pin RC OSC		• Input: Schmitt type
3. Ceramic resonator OSC		

(3) Watchdog timer option

The presence or absence of the runaway detection function (watchdog timer) may be selected by option.

(4) Options of port output configuration

For each port of P0, P1, P2, P3 (except P33/HOLD), P4, P5, P6, PC, either of the following two output configurations may be selected by option (in bit units).

Option Name	Circuit	Conditions, etc.
1. Open drain type output		P2, P3, P5, P6: Schmitt input
2. Output with pull-up resistance		P2, P3, P5, P6: Schmitt input CMOS output (P2, P3, P6, PC) or Pu MOS output (P0, P1, P4, P5) is selected according to Pch Tr drive capacity.

Main Specifications

(1) Absolute Maximum Ratings at Ta=25°C, VSS=0V

Parameter	Symbol	Applicable Pins, Remarks	Conditions	Limits	Unit	Note
Maximum Supply Voltage	VDD max	VDD		-0.3 to +7.0	V	
Input Voltage	VIN(1)	P2,P3(except P33/HOLD), P4,P5,P6		-0.3 to +15.0	V	1
	VIN(2)	Other inputs		-0.3 to VDD+0.3	V	2
Output Voltage	VOUT(1)	P2,P3(except P33/HOLD), P4,P5,P6		-0.3 to +15.0	V	1
	VOUT(2)	Other outputs		-0.3 to VDD+0.3	V	2
Output Current per Pin	ION	P0,P1,P2,P3(except P33/HOLD),PC,P4,P5,P6		20	mA	3
	-IOP(1)	P0,P1,P4,P5		2	mA	4
	-IOP(2)	P2,P3(except P33/HOLD), P6,PC		4	mA	4
Total Pin Current	ΣION(1)	P0,P1,P2,P3(except P33/HOLD),P40,P41		75	mA	3
	ΣION(2)	P5,P6,P42,P43,PC		75	mA	3
	-ΣIOP(1)	P0,P1,P2,P3(except P33/HOLD),P40,P41		25	mA	4
	-ΣIOP(2)	P5,P6,P42,P43,PC		25	mA	4
Allowable Power Dissipation	Pd max	Ta=-30 to +70°C	DIP 42S (QFP48)	600(430)	mW	5
Operating Temperature	Topr			-30 to +70	°C	
Storage Temperature	Tstg			-55 to +125	°C	

(Note 1) Applicable only when the open drain output type is selected. If other type than the open drain output is selected, the specification indicated in the column for other pins applies.

(Note 2) For OSC input/output, up to self OSC level is allowable.

(Note 3) Sink current

(Note 4) Source current (applicable only when the pull-up output type or CMOS output type is selected)

(Note 5) Reflow soldering is recommended for QFP packages.

Please consult your local representative for information on solder-bath immersion of the device.

(2) Allowable Operating Conditions at Ta=-30 to +70°C, VSS=0V unless otherwise specified

Parameter	Symbol	Applicable Pins	Conditions	Limits			Unit	Note	
				VDD(V)	min	typ			max
Operating Voltage	VDD	VDD			4.0	5.0	6.0	V	
Data Retention Voltage	VDD(H)	VDD	HOLD mode		1.8		6.0	V	
"H"-Level Input Voltage	VIH(1)	P2,P3(except P33/HOLD), P4,P5,P6	Output Nch Tr OFF	4.0 to 6.0	0.75VDD		+13.5	V	1
	VIH(2)	P33/HOLD, RES, OSC1	Output Nch Tr OFF	4.0 to 6.0	0.75VDD		VDD	V	2
	VIH(3)	P0,P1,PC,PD,PE	Output Nch Tr OFF	4.0 to 6.0	0.7VDD		VDD	V	3

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Parameter	Symbol	Applicable Pins	Conditions	Limits			Unit	Note	
				V _{DD} (V)	min	typ			max
"L"-Level Input Voltage	V _{IL} (1)	P2,P3(except P33/HOLD), P5,P6, RES,OSC1	Output Nch Tr OFF	4.0to6.0	V _{SS}		0.25V _{DD}	V	2
	V _{IL} (2)	P33/HOLD		1.8 to6.0	V _{SS}		0.25V _{DD}	V	
	V _{IL} (3)	P0, P1, P4, PC, PD, PE, TEST	Output Nch Tr OFF	4.0to6.0	V _{SS}		0.3V _{DD}	V	3
Operating Frequency (Instruction Cycle Time)	f _{OP} (TCYC)			4.0to6.0	0.4 (10)		4.35 (0.92)	MHz (μs)	
External Clock Input Conditions	Frequency	f _{ext}	OSC1	See Fig. 1. The OSC1 is used for input and the OSC2 is left open. (OSC option: External clock input)	4.0to6.0	0.4		4.35	MHz
	Pulse Width	textH textL		See Fig. 1. The OSC1 is used for input and the OSC2 is left open. (OSC option: External clock input)	4.0to6.0	70			ns
	Rise/Fall Time	textR textF		See Fig. 1. The OSC1 is used for input and the OSC2 is left open. (OSC option: External clock input)	4.0to6.0			30	ns
Self Osc Conditions	External Constants for RC OSC	C _{ext} R _{ext}	OSC1, OSC2	See Fig. 3.	4.0to6.0		100 2.7	pF kΩ	

(Note 1) Applicable to pins of open drain type. For P33/HOLD, V_{IL}(2) applies. P2, P3, P6 of CMOS output type cannot be used as input pin.

(Note 2) Applicable to pins of open drain type.

(Note 3) PC of CMOS output type cannot be used as input pin.

(3) Electrical Characteristics at Ta=-30 to +70°C, VSS=0V unless otherwise specified

Parameter	Symbol	Applicable Pins	Conditions	VDD (V)	Limits			Unit	Note
					min	typ	max		
"H"-Level Input Current	I _{IH} (1)	P2,P3 (except P33/HOLD), P4,P5,P6	V _{IN} =13.5V Output Nch Tr OFF	4.0to6.0			5.0	μA	1
	I _{IH} (2)	P0, P1, OSC1, RES, P33/HOLD	V _{IN} =VDD Output Nch Tr OFF	4.0to6.0			1.0	μA	1
	I _{IH} (3)	PC2,PC3,PD,PE	V _{IN} =VDD Output Nch Tr OFF	4.0to6.0			1.0	μA	1
"L"-Level Input Current	I _{IL} (1)	Inputs other than PC2,PC3,PD,PE	V _{IN} =VSS Output Nch Tr OFF	4.0to6.0	-1.0			μA	2
	I _{IL} (2)	PC2, PC3, PD, PE	V _{IN} =VSS Output Nch Tr OFF	4.0to6.0	-1.0			μA	2
"H"-Level Output Voltage	VOH(1)	P2, P3 (except P33/HOLD), P6, PC	I _{OH} =-1 mA	4.0to6.0	VDD-1.0			V	3
			I _{OH} =-0.1mA	4.0to6.0	VDD-0.5			V	3
	VOH(2)	P0, P1, P4, P5	I _{OH} =-200 μA	4.5	2.4			V	4
			I _{OH} =-130 μA	4.5to5.5	VDD-1.35			V	
Output Pull-up Current	I _{PO}	P0, P1, P4, P5	V _{IN} =VSS	5.5	-1.6			mA	4
"L"-Level Output Voltage	VOL(1)	P0, P1, P2, P3, P4, P5, P6, PC (except P33/HOLD)	I _{OL} =1.6mA	4.0to6.0			0.4	V	
	VOL(2)	P0,P1,P2,P3,P4,P5, P6(except P33/HOLD)	I _{OL} =10mA	4.0to6.0			1.5	V	
Output OFF-State Leakage Current	I _{OFF} (1)	P2,P3,P4,P5,P6	V _{IN} =13.5V	4.0to6.0			5.0	μA	5
	I _{OFF} (2)	P0, P1, PC	V _{IN} =VDD	4.0to6.0			1.0	μA	5
Schmitt Characteristics	Hysteresis Voltage	V _{HYS}	P2,P3,P5,P6,RES, OSC1 (RC,EXT)	4.0to6.0		0.1VDD		V	
	"H"-Level Threshold Voltage	V _{t H}			0.5VDD		0.75VDD	V	
	"L"-Level Threshold Voltage	V _{t L}			0.25VDD		0.5VDD	V	
Ceramic Resonator OSC	OSC Frequency	f _{CF}	OSC1, OSC2 See Fig. 2.	4MHz	4.0to6.0		4.0	MHz	
	OSC Stabilizing Period	t _{CS}	See Fig. 3.	4MHz	4.0to6.0		10	ms	
RC OSC Frequency	f _{RC}	OSC1, OSC2	See Fig. 4. C=100pF ± 5% R=2.7kΩ ± 1%		4.0to6.0	2.0	3.0	4.0	MHz

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Parameter	Symbol	Applicable Pins	Conditions	Limits			Unit	Note				
				VDD(V)	min	typ			max			
Serial Clock	Cycle Time	tCKCY	SCK0, SCK1	Timing of Fig. 5 and timing load of Fig. 6.	4.0 to 6.0	0.9			μS			
					4.0 to 6.0	2.0			TCYC			
	"L"/"H". Level Pulse Width	tCKL			4.0 to 6.0	0.4			μS			
					tCKH	4.0 to 6.0	1.0			TCYC		
	Rise/Fall Time	tCKR				tCKF	4.0 to 6.0			0.1	μS	
Serial Input	Data Setup Time	tICK	SIO, S11	Timing of Fig. 5, specified for SCK0, SCK1 rise (↑)	4.0 to 6.0	0.3			μS			
	Data Hold Time	tCKI			4.0 to 6.0	0.3			μS			
Serial Output	Output Delay Time	tCKO	S00, S01	Timing of Fig. 5 and timing load of Fig. 6, specified for SCK0, SCK1 fall (↓)	4.0 to 6.0			0.3	μS			
Pulse Input Conditions	"H"/"L". Level Pulse Width at INTO	tIOH	INT0	See Fig.7. • Condition under which the INTO interrupt is accepted • Condition under which the event counter/pulse width measure input by timer 0 is accepted	4.0 to 6.0	2			TCYC			
		tIOL										
	Interrupt Input "H"/"L". Level Pulse Width at Other than INTO	tIIH	INT1, INT2	• Condition under which each interrupt is accepted								
		tIIL										
"H"/"L". Level Pulse Width at PIN1	tPINH	PIN1	• Condition under which the event counter input by timer 1 is accepted									
	tPINL											
"H"/"L". Level Pulse Width at RES	tRSH	RES	• Condition under which a reset is caused									
	tRSL											
Current Dissipation at Operating Mode	IDD OP	VDD	4MHz ceramic resonator OSC	4.0 to 6.0		4.5	8		mA			
			4MHz external clock							6.5	11	mA
			RC OSC							4.0	8	mA

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Parameter	Symbol	Applicable Pins	Conditions	VDD(V)	Limits			Unit	Note
					min	typ	max		
Current Dissipation at HALT Mode	IDDHALT	VDD	4MHz ceramic resonator OSC	4.0 to 6.0		1.0	3.0	mA	
			4MHz external clock			2.0	3.5	mA	
			RC OSC			1.2	3.0	mA	
Current Dissipation at HOLD Mode	IDDHOLD	VDD		1.8 to 6.0		0.01	10.0	μA	

A/D Conversion Characteristics at Ta=-30 to +70°C, VSS=0V (A/D conversion is used in A/D mode.)

Parameter	Symbol	Applicable Pins	Conditions	VDD(V)	Limits			unit	Note
					min	typ	max		
Resolution				4.0 to 6.0		6		Bit	
Absolute Accuracy						+1	+1.5	LSB	
Linearity Error						+0.5	+1	LSB	
Conversion Time	TCAD		ADSPEED=H						
			ADSPEED=L						
Analog Input Voltage	VINAD	AN1 to AN6							

Comparator Characteristics at Ta=-30 to +70°C, VSS=0V (A/D conversion is used in comparator mode.)

Parameter	Symbol	Applicable Pins	Conditions	VDD(V)	Limits			unit	Note
					min	typ	max		
Comparison Accuracy	VCECM	AN1 to AN6		4.0 to 6.0		+1	+1.5	LSB	
Threshold Voltage	VTHCM				VSS		VDD	V	
Input Voltage	VINCM	AN1 to AN6			VSS		VDD	V	
Conversion Time	TCCM						30	μS	

- (Note 1) The input/output common ports are of open drain output type with output Nch transistor OFF. When the CMOS output type is selected, the input/output common ports cannot be used as the input pins.
- (Note 2) The input/output common ports are of open drain output type with output Nch transistor OFF. The specification for pull-up output type is specified by output pull-up current IPO. When CMOS output type is selected, the input/output common ports cannot be used as the input pins.
- (Note 3) CMOS output type and output Nch transistor OFF.
- (Note 4) Pull-up output type and output Nch transistor OFF.
- (Note 5) Open drain output type and output Nch transistor OFF.
- (Note 6) Reset mode.

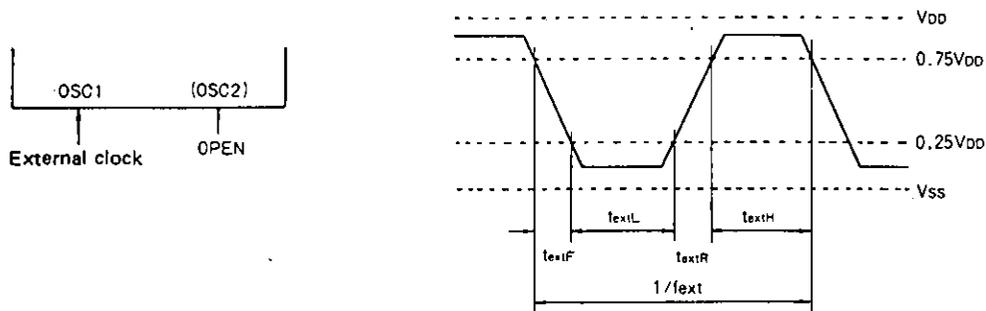


Fig. 1. External Clock Input Waveform

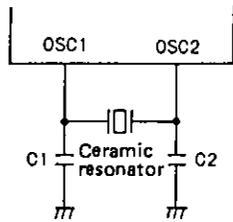


Fig. 2 Ceramic Resonator OSC Circuit

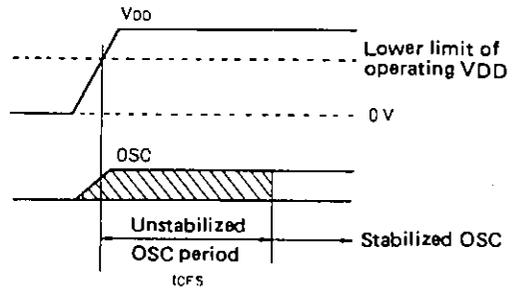


Fig. 3 OSC Stabilizing Period

External capacitor type	4 MHz (Murata) CSA4.00MG	C1	33pF ± 10%
		C2	33pF ± 10%
On-chip capacitor type	4 MHz (Murata) CST4.00MG		
	4 MHz (kyocera) KBR-4.0MES		

Table 1 Ceramic Resonator OSC-Guaranteed Constants

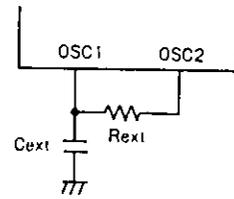


Fig. 4 RC OSC

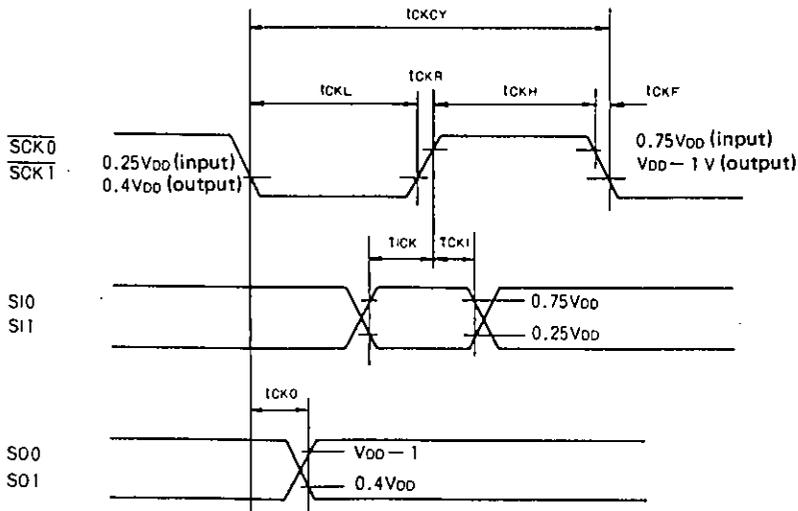


Fig. 5 Serial Input/Output Timing

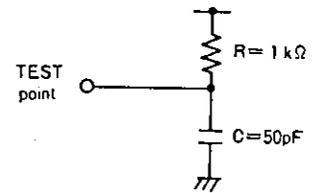


Fig. 6 Timing Load

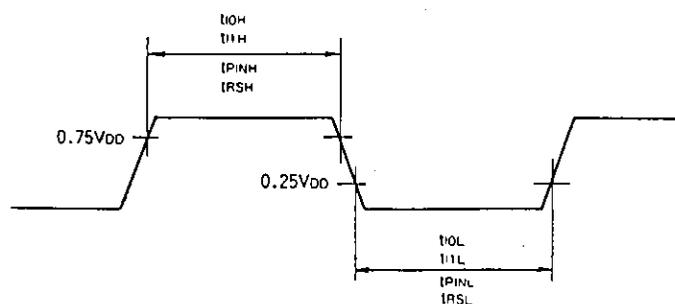


Fig. 7 $\overline{INT0}$, $\overline{INT1}$, $\overline{INT2}$, $\overline{PIN1}$, \overline{RES} Input Timing

RC OSC Characteristic of the LC66404A, 66406A, 66408A

Fig. 8 shows the RC OSC characteristic of the LC66404A, 66406A, 66408A. For the variation range of RC OSC frequency of the LC66404A, 66406A, 66408A, the following are guaranteed at the external constants only shown below.

External constants $C_{ext}=100\text{pF}$, $R_{ext}=2.7\text{k}\Omega$
 $2.0\text{MHz} \leq f_{RC} \leq 4.0\text{MHz}$ ($T_a=-30^\circ\text{C}$ to $+70^\circ\text{C}$, $V_{DD}=4.0$ to 6.0V)

If any other constants than specified above are used, RC oscillation frequency data (typ.) must be observed. (See Fig. 8.)

(Note 10) The OSC frequency at $V_{DD}=4.0$ to 6.0V , $T_a=-30$ to $+70^\circ\text{C}$ must be within the operation clock frequency range (0.4 to 4.3MHz).

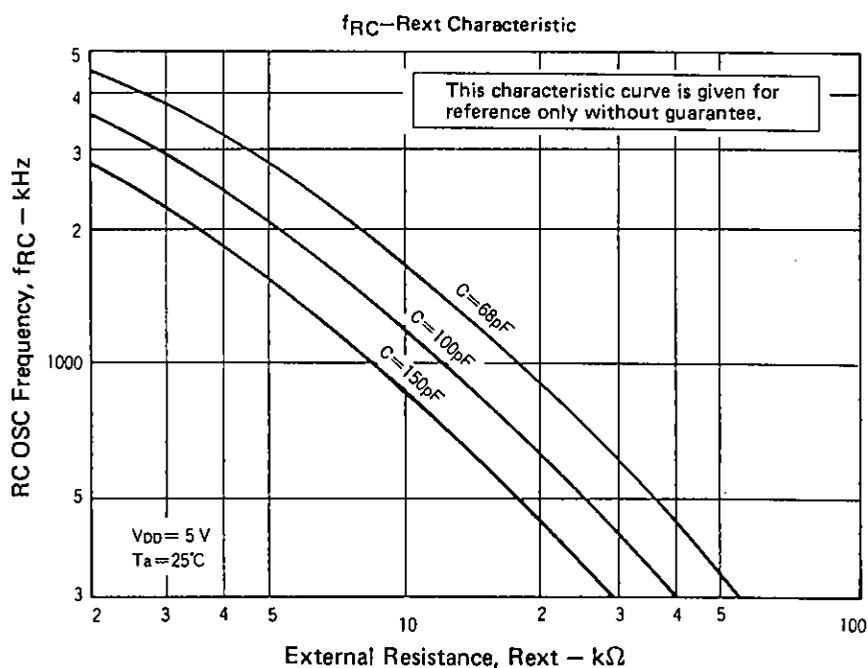
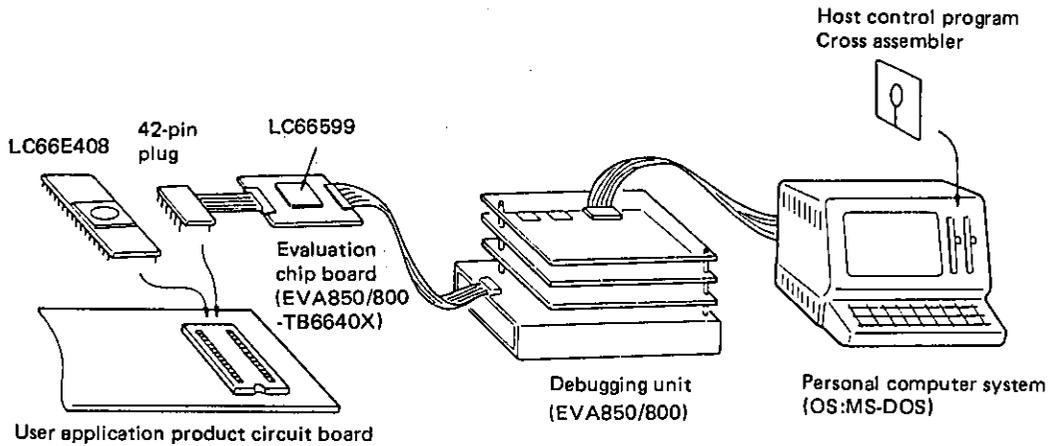


Fig. 8 RC OSC Frequency Data (Typ.)

Application Development Tools

The programs for the LC66404A, 66406A, 66408A microcomputers can be developed on the MS-DOS personal computer system (IBM-PC model system). Cross assembler for this system is provided. To help the user develop programs for the LC66404A, 66406A, 66408A microcomputers, the following development tools are prepared:



Appearance of Application Development Tools

(1) Program debugging unit (EVA850/800)

The program debugging unit (EVA850/800) is an emulator that includes the EPROM WRITE function and the serial data communications interface function between the unit itself and external systems (host computer, etc.). Application programs can be developed, corrected, and debugged at the machine language level. The debugging function can be carried out through break, step and trace operations. (Use the MPM6640X as the monitor ROM on the EVA850/800 debugging unit.)

(2) Evaluation chip board (EVA850/800-TB6640X)

The evaluation chip board sends control signals to the user application board through the 42-pin connector. Data is transferred between the I/O ports on the evaluation chip board and the user application board through the 42-pin connector. If the LC66599 evaluation chip is connected to the 42-pin plug by the output cable, the data from the LC66599 microcomputer is converted into the LC66404A, 66406A, 66408A-bound data by the plug. There are jumper connectors on the evaluation chip board. They are used to select options and status levels. Therefore, using these jumper connectors, the same input/output formats and functions as those of the LC66404A, 66406A, 66408A microcomputers can be selected on the evaluation chip board.

Jumpers

Type	OSC		Reset type selection		Power supply to the user application board through the evaluation chip board	
Jumper name	Jumper 1 (J1)		Jumper 2 (J2)		Jumper 3 (J3)	
Jumper setting and mode	EXT	External clock	INT	Reset by the RUN instruction from the host computer.	ON	VDD supply to the user application board through the evaluation chip board output.
	RC	RC OSC				
	CF	CF OSC	EXT	Reset by the reset circuit on the user application board	OFF	Power supply to the user application board from an independent power source (from the evaluation chip board)

Switch 9 to 11 (SW9 to SW11)

Type	Output level selection for ports 0,1 at the reset				Watchdog timer function selection	
Switch name	P0HL (SW11)		P1HL(SW10)		WDC (SW9)	
Switch setting and mode	+5V	Port 0 "H"	+5V	Port 1 "H"	+5V	Watchdog timer function selected
	GND	Port 0 "L"	GND	Port 1 "L"	GND	Watchdog timer function not selected

(Note) There are many other switches on the evaluation chip board. For further details, refer to the description of "Section 4. Operation" in "EVA 850/800-LC6640X Development Tool Manual".

Switches SW1 to SW8: Pull-up resistor option select

- ① Set to ON when on-chip pull-up resistor is used. Set to OPEN when open drain output type is selected.
- ② Selectable for each pin.

(3) Cross assembler

Cross assembler name (File name)	Target machine	Restriction on program development
LC66S.EXE	LC66404A, 66406A, 66408A(LC66E408/P408) (LC66599)	Restriction on SB instruction • LC66404A : SB 0 only usable • LC66406A/408A : SB 0, SB 1 usable (LC66E408/P408) • (LC66599) : SB 0, SB 1, SB 2, SB 3 usable

(4) Simulation chip (For details, refer to the catalog of the LC66E408.)

The simulation chip (LC66E408) is an EPROM-contained microcomputer. Using the dedicated conversion board (DIP: W66EP308D/408D, FLP: W66EP308Q/408Q), you can write programs in the EPROM with a commercially available PROM writer. Then, you can incorporate the simulation chip into an application product to monitor actual operations.

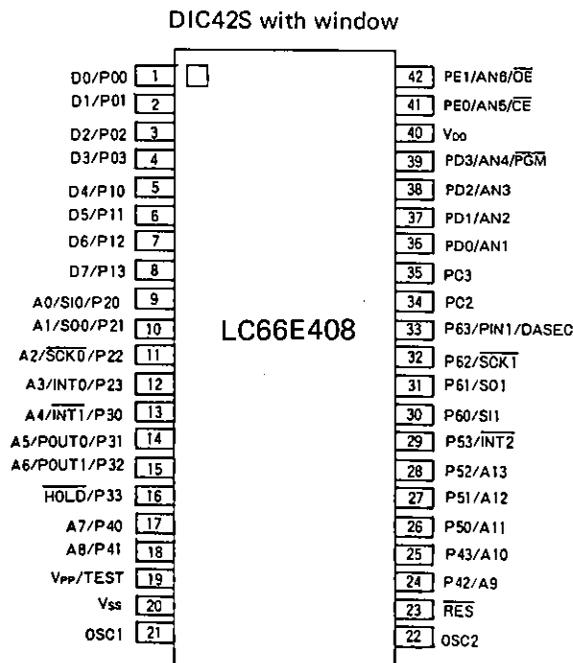
① Case outline

The LC66E408 is the same as the LC66404A, 66406A, 66408A in pin assignment and functions. The pin assignment is shown below.

② Option

Using the on-chip EPROM data (option data area and definition are shown on the next page), you can specify the options (level at port 0, 1 reset mode, watchdog timer, port output configuration) of a microcomputer to be evaluated. Thus, you can perform evaluation using the same peripheral as the board of the equipment to be mass-produced.

Pin Assignment



Option Data Area and Definition

ROM Area	Bit	Option	Relation between Option and Data	
2 0 0 0 H	7	Unused	Fixed at 0	
	6			
	5			
	4	OSC option		1=Ceramic resonator OSC 0=RC OSC, external clock
	3	Unused		Fixed at 0
	2	P1		Level at reset mode
1	P0			
	0	Watchdog timer option	1=Available, 0=Unavailable	
2 0 0 1 H	7	P13	Output configuration	1 =PU, 0 =OD
	6	P12		
	5	P11		
	4	P10	Output configuration	
	3	P03		
	2	P02		
	1	P01		
0	P00			
2 0 0 2 H	7	Unused	Fixed at 0	
	6	P32		Output configuration
	5	P31		
	4	P30		
	3	P23		Output configuration
	2	P22		
	1	P21		
0	P20			
2 0 0 3 H	7	P53	Output configuration	1 =PU, 0 =OD
	6	P52		
	5	P51		
	4	P50	Output configuration	
	3	P43		
	2	P42		
	1	P41		
0	P40			
2 0 0 4 H	7~4	Unused	Output configuration	1 =PU, 0 =OD
	3	P63		
	2	P62		
	1	P61		
	0	P60		
2 0 0 5 H	7~0	Unused	Fixed at 0	
2 0 0 6 H	7~0	Unused	Fixed at 0	
2 0 0 7 H	7~4	Unused	Output configuration	1 =PU, 0 =OD
	3	PC3		
	2	PC2		
	1	Unused	Fixed at 0	
0	Unused	Fixed at 0		

Remarks:

PU --- Pull-up MOS type resistance output

OD --- Open drain output

Note: The pull-up MOS type resistance output represents the pull-up MOS (PU MOS) type resistor output circuit and the complementary MOS (CMOS) type output circuit.

LC6640X SERIES INSTRUCTION SET (BY FUNCTION)

- Symbol Description
- AC : Accumulator
- E : E register
- CF : Carry flag
- ZF : Zero flag
- HL : Data pointer DPH, DPL
- XY : Data pointer DPX, DPY
- M : Data memory
- M (HL) : Data memory contents specified by data pointer DPH, DPL
- M (XY) : Data memory contents specified by supplementary data pointer DPX, DPY
- M2 (HL) : 2-word data memory contents specified by data pointer DPH, DPL.
In this case, the accessed data memory area address must be multiples of 2 (even address).
- SP : Stack pointer
- M2 (SP) : 2-word data memory contents specified by stack pointer
- M4 (SP) : 4-word data memory contents specified by stack pointer
- in : n-bit immediate data
- t2 : Bit specification

t2	11	10	01	00
Bit	2 ³	2 ²	2 ¹	2 ⁰

- PCh : Bits 8 to 11 of PC
- PCm : Bits 4 to 7 of PC
- PCI : Bits 0 to 3 of PC
- Fn : User's flag n=0 to 15
- TIMER0 : Timer 0
- TIMER1 : Timer 1
- SIO : Serial register
- P : Port
- P (i4) : Port contents specified by 4-bit immediate data
- INT : Interrupt enable flag
- (), [] : Contents
- ← : Transfer direction and operation result
- ⊕ : Exclusive logical sum
- ∧ : Logical product
- ∨ : Logical sum
- +
-
- : 1's complement

Instruction type	Mnemonics		Instruction code		Bytes	Cycles	Function	Description	Status flags affected	Remarks
			D ₇ D ₆ D ₅ D ₄	D ₃ D ₂ D ₁ D ₀						
Accumulator manipulation instructions	CLA	Clear AC	1 0 0 0	0 0 0 0	1	1	AC ← 0 (Equivalent to LAI 0)	Clears AC.	ZF	Only the first instruction is effective if executed continuously (loop function).
	DAA	Decimal adjust AC in addition	1 1 0 0 0 0 1 0	1 1 1 1 0 1 1 0	2	2	AC ← (AC) + 6 (Equivalent to ADI 6)	Adds 6 to AC.	ZF	
	DAS	Decimal adjust AC in subtraction	1 1 0 0 0 0 1 0	1 1 1 1 1 0 1 0	2	2	AC ← (AC) - 10 (Equivalent to ADI 0AH)	Adds 10 to AC.	ZF	
	CLC	Clear CF	0 0 0 1	1 1 1 0	1	1	CF ← 0	Clears CF.	CF	
	STC	Set CF	0 0 0 1	1 1 1 1	1	1	CF ← 1	Sets CF.	CF	
	CMA	Complement AC	0 0 0 1	1 0 0 0	1	1	AC ← \overline{AC}	Gives 1's complement of (invert) AC.	ZF	
	IA	Increment AC	0 0 0 1	0 1 0 0	1	1	AC ← (AC) + 1	Adds 1 to AC.	ZF, CF	
	DA	Decrement AC	0 0 1 0	0 1 0 0	1	1	AC ← (AC) - 1	Subtracts 1 from AC.	ZF, CF	
	RAR	Rotate AC right through CF	0 0 0 1	0 0 0 0	1	1	AC ₇ ← (CF), AC _n ← (AC _{n+1}), CF ← (AC ₀)	Rotates AC right through CF.	CF	
	RAL	Rotate AC left through CF	0 0 0 0	0 0 0 1	1	1	AC ₀ ← (CF), AC _{n+1} ← (AC _n), CF ← (AC ₇)	Rotates AC left through CF.	CF, ZF	
	TAE	Transfer AC to E	0 1 0 0	0 1 0 1	1	1	E ← (AC)	Transfers the AC contents to the E register.		
	TEA	Transfer E to AC	0 1 0 0	0 1 1 0	1	1	AC ← (E)	Transfers the E register contents to AC.	ZF	
	XAE	Exchange AC with E	0 1 0 0	0 1 0 0	1	1	(AC) ↔ (E)	Exchanges the contents of the AC and E register.		
Memory manipulation instructions	IM	Increment M	0 0 0 1	0 0 1 0	1	1	M(HL) ← (M(HL)) + 1	Adds 1 to M(HL).	ZF, CF	
	DM	Decrement M	0 0 1 0	0 0 1 0	1	1	M(HL) ← (M(HL)) - 1	Subtracts 1 from M(HL).	ZF, CF	
	IMDR i8	Increment M direct	1 1 0 0 i ₇ i ₆ i ₅ i ₄	0 1 1 1 i ₃ i ₂ i ₁ i ₀	2	2	M(i8) ← (M(i8)) + 1	Adds 1 to M(i8).	ZF, CF	
	DMDR i8	Decrement M direct	1 1 0 0 i ₇ i ₆ i ₅ i ₄	0 0 1 1 i ₃ i ₂ i ₁ i ₀	2	2	M(i8) ← (M(i8)) - 1	Subtracts 1 from M(i8).	ZF, CF	
	SMB t2	Set M data bit	0 0 0 0	1 1 t ₁ t ₀	1	1	(M(HL), t ₂) ← 1	Sets a bit specified by t ₁ , t ₀ of M(HL).		
	RMB t2	Reset M data bit	0 0 1 0	1 1 t ₁ t ₀	1	1	(M(HL), t ₂) ← 0	Resets a bit specified by t ₁ , t ₀ of M(HL).	ZF	
Operation/Comparison instructions	AD	Add M to AC	0 0 0 0	0 1 1 0	1	1	AC ← (AC) + (M(HL))	Adds together the contents of AC and M(HL) in binary and stores the result in AC.	ZF, CF	
	ADDR i8	Add M direct to AC	1 1 0 0 i ₇ i ₆ i ₅ i ₄	1 0 0 1 i ₃ i ₂ i ₁ i ₀	2	2	AC ← (AC) + (M(i8))	Adds together the contents of AC and M(i8) in binary and stores the result in AC.	ZF, CF	
	ADC	Add M to AC with CF	0 0 0 0	0 0 1 0	1	1	AC ← (AC) + (M(HL)) + (CF)	Adds together the contents of AC, M(HL), and CF in binary and stores the result in AC.	ZF, CF	
	ADI i4	Add immediate data to AC	1 1 0 0 0 0 1 0	1 1 1 1 i ₃ i ₂ i ₁ i ₀	2	2	AC ← (AC) + i ₃ , i ₂ , i ₁ , i ₀	Adds together the contents of AC and immediate data in binary and stores the result in AC.	ZF	
	SUBC	Subtract AC from M with CF	0 0 0 1	0 1 1 1	1	1	AC ← (M(HL)) - (AC) - (CF)	Subtracts the contents of AC from M(HL) with CF in binary and stores the result in AC.	ZF, CF	CF=0 if there is a borrow while CF=1 if there is no borrow.
	ANDA	AND M with AC then store AC	0 0 0 0	0 1 1 1	1	1	AC ← (AC) ∧ (M(HL))	Performs a logical AND operation between AC and M(HL) and stores the result in AC.	ZF	
	ORA	OR M with AC then store AC	0 0 0 0	0 1 0 1	1	1	AC ← (AC) ∨ (M(HL))	Performs a logical OR operation between AC and M(HL) and stores the result in AC.	ZF	
	EXL	Exclusive OR M with AC then store AC	0 0 0 1	0 1 0 1	1	1	AC ← (AC) ⊕ (M(HL))	Performs a logical exclusive OR operation between AC and M(HL) and stores the result in AC.	ZF	
	ANDM	AND M with AC then store M	0 0 0 0	0 0 1 1	1	1	M(HL) ← (AC) ∧ (M(HL))	Performs a logical AND operation between AC and M(HL) and stores the result in M(HL).	ZF	
ORM	OR M with AC then store M	0 0 0 0	0 1 0 0	1	1	M(HL) ← (AC) ∨ (M(HL))	Performs a logical OR operation between AC and M(HL) and stores the results in M(HL).	ZF		

Instruction type	Mnemonics	Instruction code		Bytes	Cycles	Function	Description	Status flags affected	Remarks													
		D ₇ D ₆ D ₅ D ₄	D ₃ D ₂ D ₁ D ₀																			
Operation/Comparison instructions	CM	Compare AC with M	0 0 0 1	0 1 1 0	1	1	$[M(HL)] + (AC) + 1$	Compares the contents of AC and M(HL) and then sets/resets the carry flag (CF) and zero flag (ZF).	ZF, CF													
								<table border="1"> <tr> <th>Comparison relations</th> <th>CF</th> <th>ZF</th> </tr> <tr> <td>$(M(HL)) > (AC)$</td> <td>0</td> <td>0</td> </tr> <tr> <td>$(M(HL)) = (AC)$</td> <td>1</td> <td>1</td> </tr> <tr> <td>$(M(HL)) < (AC)$</td> <td>1</td> <td>0</td> </tr> </table>	Comparison relations	CF	ZF	$(M(HL)) > (AC)$	0	0	$(M(HL)) = (AC)$	1	1	$(M(HL)) < (AC)$	1	0		
	Comparison relations	CF	ZF																			
	$(M(HL)) > (AC)$	0	0																			
$(M(HL)) = (AC)$	1	1																				
$(M(HL)) < (AC)$	1	0																				
CI i4	Compare AC with immediate data	1 1 0 0 1 0 : 0	1 1 1 1 i ₃ i ₂ i ₁ i ₀	2	2	$\frac{1}{2} [i_7 i_1 i_0] + (AC) - 1$	Compares the contents of the accumulator (AC) and immediate data (i ₃ i ₂ i ₁ i ₀) and sets/resets the zero flag (ZF) and carry flag (CF).	ZF, CF														
							<table border="1"> <tr> <th>Comparison relations</th> <th>CF</th> <th>ZF</th> </tr> <tr> <td>$i_3 i_2 i_1 i_0 > AC$</td> <td>0</td> <td>0</td> </tr> <tr> <td>$i_3 i_2 i_1 i_0 = AC$</td> <td>1</td> <td>1</td> </tr> <tr> <td>$i_3 i_2 i_1 i_0 < AC$</td> <td>1</td> <td>0</td> </tr> </table>	Comparison relations	CF	ZF	$i_3 i_2 i_1 i_0 > AC$	0	0	$i_3 i_2 i_1 i_0 = AC$	1	1	$i_3 i_2 i_1 i_0 < AC$	1	0			
Comparison relations	CF	ZF																				
$i_3 i_2 i_1 i_0 > AC$	0	0																				
$i_3 i_2 i_1 i_0 = AC$	1	1																				
$i_3 i_2 i_1 i_0 < AC$	1	0																				
	CLI i4	Compare DPL with immediate data	1 1 0 0 1 0 1 1	1 1 1 1 i ₃ i ₂ i ₁ i ₀	2	2	ZF ← 1 if (DPL) = i ₃ i ₂ i ₁ i ₀ ZF ← 0 if (DPL) ≠ i ₃ i ₂ i ₁ i ₀	Compares the contents of DPL and immediate data and sets the zero flag (ZF) if they are equal, or resets the flag if not equal.	ZF													
	CMB i2	Compare AC bit with M data bit	1 1 0 0 1 1 0 1	1 1 1 1 0 0 t ₁ t ₀	2	2	ZF ← 1 if (AC, t ₂) = (M(HL), t ₂) ZF ← 0 if (AC, t ₂) ≠ (M(HL), t ₂)	Compares the contents of AC and M(HL) bit specified by the 2 bits (t ₁ and t ₂) of the instruction and sets the zero flag (ZF) if they are equal, or resets the flag if not equal.	ZF													
Load/store instructions	LAE	Load AC and E from M2 (HL)	0 1 0 1	1 1 0 0	1	1	AC ← M(HL) E ← M(HL + 1)	Loads the contents of M2(HL) into the AC and the E register.														
	LAI i4	Load AC with immediate data	1 0 0 0	i ₃ i ₂ i ₁ i ₀	1	1	AC ← i ₃ i ₂ i ₁ i ₀	Loads immediate data into AC.	ZF	Only the first instruction is effective if executed continuously (skip function).												
	LADR i8	Load AC from M direct	1 1 0 0 i ₇ i ₆ i ₅ i ₄	0 0 0 1 i ₃ i ₂ i ₁ i ₀	2	2	AC ← (M(i8))	Loads the contents of M(i8) into AC.	ZF													
	S	Store AC to M	0 1 0 0	0 1 1 1	1	1	M(HL) ← (AC)	Stores the contents of AC into M(HL).														
	SAE	Store AC and E to M2 (HL)	0 1 0 1	1 1 1 0	1	1	M(HL) ← (AC) M(HL + 1) ← (E)	Stores the contents of AC and the E register into M2(HL).														
	LA reg	Load AC from M(reg)	0 1 0 0	1 0 t ₀ 0	1	1	AC ← (M(reg))	Loads the contents of M(reg) into AC. reg is either an HL or XY.	ZF													
								<table border="1"> <tr> <th>reg</th> <th>t₀</th> </tr> <tr> <td>HL</td> <td>0</td> </tr> <tr> <td>XY</td> <td>1</td> </tr> </table>	reg	t ₀	HL	0	XY	1								
	reg	t ₀																				
	HL	0																				
	XY	1																				
LA reg, i	Load AC from M(reg) then increment reg	0 1 0 0	1 0 t ₀ 1	1	2	AC ← (M(reg)) DPL ← (DPL) + 1 or DPY ← (DPY) + 1	Loads the contents of M(reg) into the accumulator (AC). reg is either an HL or XY. After loading, increments the contents of DPL or DPY. Refer to the LA reg instruction for the relationship between reg and t ₀ .	ZF	ZF status depends on DPL or DPY increment result.													
LA reg, D	Load AC from M(reg) then decrement reg	0 1 0 1	1 0 t ₀ 1	1	2	AC ← (M(reg)) DPL ← (DPL) - 1 or DPY ← (DPY) - 1	Loads the contents of M(reg) into AC. reg is either an HL or XY. After loading, decrements the contents of DPL or DPY. Refer to the LA reg instruction for the relationship between reg and t ₀ .	ZF	ZF status depends on DPL or DPY decrement result.													
XA reg	Exchange AC with M (reg)	0 1 0 0	1 1 t ₀ 0	1	1	(AC) ↔ (M(reg))	Exchanges the contents of AC and M(reg). reg is either an HL or XY.															
							<table border="1"> <tr> <th>reg</th> <th>t₀</th> </tr> <tr> <td>HL</td> <td>0</td> </tr> <tr> <td>XY</td> <td>1</td> </tr> </table>	reg	t ₀	HL	0	XY	1									
reg	t ₀																					
HL	0																					
XY	1																					
XA reg, i	Exchange AC with M (reg) then increment reg	0 1 0 0	1 1 t ₀ 1	1	2	(AC) ↔ (M(reg)) DPL ← (DPL) + 1 or DPY ← (DPY) - 1	Exchanges the contents of AC and M(reg). reg is either an HL or XY. After exchanging, increments the contents of DPL or DPY. Refer to the XA reg instruction for the relationship between reg and t ₀ .	ZF	ZF status depends on DPL or DPY increment result.													
XA reg, D	Exchange AC with M (reg) then decrement reg	0 1 0 1	1 1 t ₀ 1	1	2	(AC) ↔ (M(reg)) DPL ← (DPL) - 1 or DPY ← (DPY) - 1	Exchanges the contents of AC and M(reg). reg is either an HL or XY. After exchanging, decrements the contents of DPL or DPY. Refer to the XA reg instruction for the relationship between reg and t ₀ .	ZF	ZF status depends on DPL or DPY decrement result.													
XADR i8	Exchange AC with M direct	1 1 0 0 i ₇ i ₆ i ₅ i ₄	1 0 0 0 i ₃ i ₂ i ₁ i ₀	2	2	(AC) ↔ (M(i8))	Exchanges the contents of AC and M(i8).															

Instruction type	Mnemonics	Instruction code		Bytes	Cycles	Function	Description	Status flags affected	Remarks
		D ₇ D ₆ D ₅ D ₄	D ₃ D ₂ D ₁ D ₀						
Load/store instructions	LEAI i8 Load E & AC with immediate data	1 1 0 0 l ₇ l ₆ l ₅ l ₄	0 1 1 0 l ₃ l ₂ l ₁ l ₀	2	2	E ← l ₇ l ₆ l ₅ l ₄ AC ← l ₃ l ₂ l ₁ l ₀	Loads immediate data i8 into the E register and the accumulator (AC).		
	RTBL Read table data from program ROM	0 1 0 1	1 0 1 0	1	2	E, AC ← (ROM(PCh, E, AC))	First, replace the contents of lower 8 bits of PC with the E register and AC contents. Then, loads the ROM data at an address specified by the new contents of the lower 8 bits of PC into the E register and AC.		
	RTBLP Read table data from program ROM then output to P4,5	0 1 0 1	1 0 0 0	1	2	Port 4, 5 ← (ROM(PCh, E, AC))	First, replaces the contents of lower 8 bits of AC with the E register and AC contents. Then, outputs the ROM data at an address specified by the new contents of the lower 8 bits of PC to ports 4 and 5.		
Data pointer manipulation instructions	LDZ i4 Load DP _H with zero and DP _L with immediate data respectively	0 1 1 0	l ₃ l ₂ l ₁ l ₀	1	1	DP _H ← 0 DP _L ← l ₃ l ₂ l ₁ l ₀	Loads the data of 0 (zero) and immediate data i4 into the DPH and DPL respectively.		
	LHI i4 Load DP _H with immediate data	1 1 0 0 0 0 0 0	l ₃ l ₂ l ₁ l ₀	2	2	DP _H ← l ₃ l ₂ l ₁ l ₀	Loads immediate data i4 into the DPH.		
	LLI i4 Load DP _L with immediate data	1 1 0 0 0 0 0 1	l ₃ l ₂ l ₁ l ₀	2	2	DP _L ← l ₃ l ₂ l ₁ l ₀	Loads immediate data i4 into the DPL.		
	LHLI i8 Load DP _H , DP _L with immediate data	1 1 0 0 l ₇ l ₆ l ₅ l ₄	0 0 0 0 l ₃ l ₂ l ₁ l ₀	2	2	DP _H ← l ₇ l ₆ l ₅ l ₄ DP _L ← l ₃ l ₂ l ₁ l ₀	Loads immediate data into the DPH and DPL.		
	LXYI i8 Load DP _X , DP _Y with immediate data	1 1 0 0 l ₇ l ₆ l ₅ l ₄	0 0 1 0 l ₃ l ₂ l ₁ l ₀	2	2	DP _X ← l ₇ l ₆ l ₅ l ₄ DP _Y ← l ₃ l ₂ l ₁ l ₀	Loads immediate data into the DP _X and DP _Y .		
	IL Increment DP _L	0 0 0 1	0 0 0 1	1	1	DP _L ← (DP _L) + 1	Increments the contents of the DP _L by 1.	ZF	
	DL Decrement DP _L	0 0 1 0	0 0 0 1	1	1	DP _L ← (DP _L) - 1	Decrements the contents of the DP _L by 1.	ZF	
	IY Increment DP _Y	0 0 0 1	0 0 1 1	1	1	DP _Y ← (DP _Y) + 1	Increments the contents of the DP _Y by 1.	ZF	
	DY Decrement DP _Y	0 0 1 0	0 0 1 1	1	1	DP _Y ← (DP _Y) - 1	Decrements the contents of the DP _Y by 1.	ZF	
	TAH Transfer AC to DP _H	1 1 0 0 1 1 1 1	1 1 1 1 0 0 0 0	2	2	DP _H ← (AC)	Transfers the contents of the accumulator (AC) to the DPH.		
	THA Transfer DP _H to AC	1 1 0 0 1 1 1 0	1 1 1 1 0 0 0 0	2	2	AC ← (DP _H)	Transfers the contents of the DPH to the AC.	ZF	
	XAH Exchange AC with DP _H	0 1 0 0	0 0 0 0	1	1	(AC) ↔ (DP _H)	Exchanges the contents of the accumulator (AC) and the DPH.		
	TAL Transfer AC to DP _L	1 1 0 0 1 1 1 1	1 1 1 1 0 0 0 1	2	2	DP _L ← (AC)	Transfers the contents of the accumulator (AC) to the DPL.		
	TLA Transfer DP _L to AC	1 1 0 0 1 1 1 0	1 1 1 1 0 0 0 1	2	2	AC ← (DP _L)	Transfers the contents of the DPL to the accumulator (AC).	ZF	
	XAL Exchange AC with DP _L	0 1 0 0	0 0 0 1	1	1	(AC) ↔ (DP _L)	Exchanges the contents of the AC and DPL.		
	TAX Transfer AC to DP _X	1 1 0 0 1 1 1 1	1 1 1 1 0 0 1 0	2	2	DP _X ← (AC)	Transfers the contents of the accumulator (AC) to the DP _X .		
	TXA Transfer DP _X to AC	1 1 0 0 1 1 1 0	1 1 1 1 0 0 1 0	2	2	AC ← (DP _X)	Transfers the contents of DP _X to the AC.	ZF	
	XAX Exchange AC with DP _X	0 1 0 0	0 0 1 0	1	1	(AC) ↔ (DP _X)	Exchanges the contents of the AC and DP _X .		
	TAY Transfer AC to DP _Y	1 1 0 0 1 1 1 1	1 1 1 1 0 0 1 1	2	2	DP _Y ← (AC)	Transfers the contents of the accumulator (AC) to the DP _Y .		
	TYA Transfer DP _Y to AC	1 1 0 0 1 1 1 0	1 1 1 1 0 0 1 1	2	2	AC ← (DP _Y)	Transfers the contents of the DP _Y to the AC.	ZF	
XAY Exchange AC with DP _Y	0 1 0 0	0 0 1 1	1	1	(AC) ↔ (DP _Y)	Exchanges the contents of the accumulator (AC) and the DP _Y .			
Flag manipulation instructions	SFB n4 Set flag bit	0 1 1 1	n ₃ n ₂ n ₁ n ₀	1	1	F _n ← 1	Sets a flag specified by n4.		
	RFB n4 Reset flag bit	0 0 1 1	n ₃ n ₂ n ₁ n ₀	1	1	F _n ← 0	Resets a flag specified by n4.	ZF	
Jump/subroutine instructions	JMP addr Jump in the current bank	1 1 1 0 P ₇ P ₆ P ₅ P ₄	P ₁₁ P ₁₀ P ₉ P ₈ P ₃ P ₂ P ₁ P ₀	2	2	PC ₁₂ ← PC ₁₂ PC ₁₁ - 0 - P ₁₁ - P ₀	Jumps to an address specified by immediate data P ₁₁ - P ₀ in the current bank.		When executed immediately after the BANK instruction, PC ₁₂ ← (PC ₁₂)
	JPEA Jump to the address stored at E and AC in the current page	0 0 1 0	0 1 1 1	1	1	PC ₁₂ - PC ₈ - PC ₁₂ - PC ₈ PC ₇ - 4 - (E) PC ₃ - 0 - (AC)	Jumps to an address specified by the contents of the E register and accumulator (AC) which have replaced the contents of lower 8 bits of the program counter (PC).		

Instruction type	Mnemonics		Instruction code		Bytes	Cycles	Function	Description	Status flags affected	Remarks															
			D ₇ D ₆ D ₅ D ₄	D ₃ D ₂ D ₁ D ₀																					
Jump/subroutine instructions	CAL addr	Call subroutine	0 1 0 1 P ₇ P ₆ P ₅ P ₄	0 P ₁₀ P ₉ P ₈ P ₃ P ₂ P ₁ P ₀	2	2	PC12-11-0 PC10-0- P ₁₀ -P ₀ M4(SP)-(CF, ZF, PC13-0) SP-(SP)-4	Calls a subroutine.																	
	CZP addr	Call subroutine in the zero page	1 0 1 0	P ₃ P ₂ P ₁ P ₀	1	2	PC12-6, PC1-0-0 PC5-2- P ₃ -P ₀ M4(SP)-(CF, ZF, PC13-0) SP-SP-4	Calls a subroutine in page 0 of bank 0.																	
	BANK	Change bank	0 0 0 1	1 0 1 1	1	1		Changes memory banks and register banks.																	
	PUSH reg	Push reg on M2(SP)	1 1 0 0 1 1 1 1	1 1 1 1 i ₁ i ₀ 0	2	2	M2(SP)-(reg) SP-(SP)-2	Stores the contents of reg into the M2(SP) and then subtracts 2 from the stack pointer (SP). <table border="1" style="margin-left: auto; margin-right: auto;"> <tr> <td>reg</td> <td>i₁</td> <td>i₀</td> </tr> <tr> <td>HL</td> <td>0</td> <td>0</td> </tr> <tr> <td>XY</td> <td>0</td> <td>1</td> </tr> <tr> <td>AE</td> <td>1</td> <td>0</td> </tr> <tr> <td>Inhibited</td> <td>1</td> <td>1</td> </tr> </table>	reg	i ₁	i ₀	HL	0	0	XY	0	1	AE	1	0	Inhibited	1	1		
	reg	i ₁	i ₀																						
	HL	0	0																						
	XY	0	1																						
AE	1	0																							
Inhibited	1	1																							
POP reg	Pop reg off M2(SP)	1 1 0 0 1 1 1 0	1 1 1 1 i ₁ i ₀ 0	2	2	SP-(SP)+2 reg-(M2(SP))	Stores the contents of reg into the M2(SP) and then increments the contents of the stack pointer (SP) by 2 and loads the contents of M2 (SP) into a reg. Refer to the PUSH reg instruction for the relationship between i10 and reg.																		
RT	Return from subroutine	0 0 0 1	1 1 0 0	1	2	SP-(SP)+4 PC-(M4(SP))	Returns execution from a subroutine or interrupt processing routine back to the routine that called it. The contents of the carry flag (CF) and zero flag (ZF) are not returned from the stack area.																		
RTI	Return from interrupt routine	0 0 0 1	1 1 0 1	1	2	SP-(SP)+4 PC-(M4(SP)) CF, ZF-(M4(SP))	Returns execution from a subroutine or interrupt processing routine back to the routine that called it. The contents of the carry flag (CF) and zero flag (ZF) are returned from the stack area.	ZF, CF																	
Branch instructions	BA12 addr	Branch on AC bit	1 1 0 1 P ₇ P ₆ P ₅ P ₄	0 0 t ₁ t ₀ P ₃ P ₂ P ₁ P ₀	2	2	PC7-0-P ₇ P ₆ P ₅ P ₄ P ₃ P ₂ P ₁ P ₀ if(AC, t2)= 1	Transfers execution to an address specified by the contents of P7 to P0 in the current page if a bit specified by immediate data t1t0 of AC is 1 (program branch).																	
	BN12 addr	Branch on no AC bit	1 0 0 1 P ₇ P ₆ P ₅ P ₄	0 0 t ₁ t ₀ P ₃ P ₂ P ₁ P ₀	2	2	PC7-0-P ₇ P ₆ P ₅ P ₄ P ₃ P ₂ P ₁ P ₀ if(AC, t2)= 0	Transfers execution to an address specified by the contents of P7 to P0 in the current page if a bit specified by immediate data t1t0 of AC is 0 (program branch).																	
	BM12 addr	Branch on M bit	1 1 0 1 P ₇ P ₆ P ₅ P ₄	0 1 t ₁ t ₀ P ₃ P ₂ P ₁ P ₀	2	2	PC7-0-P ₇ P ₆ P ₅ P ₄ P ₃ P ₂ P ₁ P ₀ if(M(HL), t2)=1	Transfers execution to an address specified by the contents of P7 to P0 in the current page if a bit specified by immediate data t1t0 of M(HL) is 1 (program branch).																	
	BNM12 addr	Branch on no M bit	1 0 0 1 P ₇ P ₆ P ₅ P ₄	0 1 t ₁ t ₀ P ₃ P ₂ P ₁ P ₀	2	2	PC7-0-P ₇ P ₆ P ₅ P ₄ P ₃ P ₂ P ₁ P ₀ if(M(HL), t2)=0	Transfers execution to an address specified by the contents of P7 to P0 in the current page if a bit specified by immediate data t1t0 of M(HL) is 0 (program branch).																	
	BPl2 addr	Branch on Port bit	1 1 0 1 P ₇ P ₆ P ₅ P ₄	1 0 t ₁ t ₀ P ₃ P ₂ P ₁ P ₀	2	2	PC7-0-P ₇ P ₆ P ₅ P ₄ P ₃ P ₂ P ₁ P ₀ if(P(DPL), t2)=1	Transfers execution to an address specified by the contents of P7 to P0 in the current page if a bit specified by immediate data t1t0 of the port accessed by DPL is 1 (program branch).		Used to manipulate internal control registers if executed immediately after the BANK instruction. In this case, the internal control registers must be readable.															
	BNPl2 addr	Branch on no Port bit	1 0 0 1 P ₇ P ₆ P ₅ P ₄	1 0 t ₁ t ₀ P ₃ P ₂ P ₁ P ₀	2	2	PC7-0-P ₇ P ₆ P ₅ P ₄ P ₃ P ₂ P ₁ P ₀ if(P(DPL), t2)=0	Transfers execution to an address specified by the contents of P7 to P0 in the current page if a bit specified by immediate data t1t0 of the port accessed by DPL is 0 (program branch).		Same as above.															
	BC addr	Branch on CF	1 1 0 1 P ₇ P ₆ P ₅ P ₄	1 1 0 0 P ₃ P ₂ P ₁ P ₀	2	2	PC7-0-P ₇ P ₆ P ₅ P ₄ P ₃ P ₂ P ₁ P ₀ if(CF)=1	Transfers execution to an address specified by the contents of P7 to P0 in the current page if the content of the carry flag (CF) is 1 (program branch).																	
	BNC addr	Branch on no CF	1 0 0 1 P ₇ P ₆ P ₅ P ₄	1 1 0 0 P ₃ P ₂ P ₁ P ₀	2	2	PC7-0-P ₇ P ₆ P ₅ P ₄ P ₃ P ₂ P ₁ P ₀ if(CF)=0	Transfers execution to an address specified by the contents of P7 to P0 in the current page if the content of the carry flag (CF) is 0 (program branch).																	
	BZ addr	Branch on ZF	1 1 0 1 P ₇ P ₆ P ₅ P ₄	1 1 0 1 P ₃ P ₂ P ₁ P ₀	2	2	PC7-0-P ₇ P ₆ P ₅ P ₄ P ₃ P ₂ P ₁ P ₀ if(ZF)=1	Transfers execution to an address specified by the contents of P7 to P0 in the current page if the content of the zero flag (ZF) is 1 (program branch).																	
	BNZ addr	Branch on no ZF	1 0 0 1 P ₇ P ₆ P ₅ P ₄	1 1 0 1 P ₃ P ₂ P ₁ P ₀	2	2	PC7-0-P ₇ P ₆ P ₅ P ₄ P ₃ P ₂ P ₁ P ₀ if(ZF)=0	Transfers execution to an address specified by the contents of P7 to P0 in the current page if the content of the zero flag (ZF) is 0 (program branch).																	

LC66404A,66406A,66408A

Instruction type	Mnemonics		Instruction code		Bytes	Cycles	Function	Description	Status flags affected	Remarks
			D ₇ D ₆ D ₅ D ₄	D ₃ D ₂ D ₁ D ₀						
Branch instructions	BFn4 addr	Branch on flag bit	1 1 1 1 P ₇ P ₆ P ₅ P ₄	n ₃ n ₂ n ₁ n ₀ P ₃ P ₂ P ₁ P ₀	2	2	PC7-0 ← P ₇ P ₆ P ₅ P ₄ P ₃ P ₂ P ₁ P ₀ if(Fn) = 1	Transfers execution to an address specified by the contents of P7 to P0 in the current page if the content of the flag specified by n3n2n1n0 is 1. The flag is one of the 16 flags.		
	BNFn4 addr	Branch on no flag bit	1 0 1 1 P ₇ P ₆ P ₅ P ₄	n ₃ n ₂ n ₁ n ₀ P ₃ P ₂ P ₁ P ₀	2	2	PC7-0 ← P ₇ P ₆ P ₅ P ₄ P ₃ P ₂ P ₁ P ₀ if(Fn) = 0	Transfers execution to an address specified by the contents of P7 to P0 in the current page if the content of the flag specified by n3n2n1n0 is 0. The flag is one of the 16 flags.		
Input/output instructions	IPO	Input port 0 to AC	0 0 1 0	0 0 0 0	1	1	AC ← (P0)	Inputs the contents of port 0 to the accumulator (AC).	ZF	
	IP	Input port to AC	0 0 1 0	0 1 1 0	1	1	AC ← (P(DPL))	Inputs the contents of port accessed by DPL to the accumulator (AC).	ZF	
	IPM	Input port to M	0 0 0 1	1 0 0 1	1	1	M(HL) ← (P(DPL))	Inputs the contents of port accessed by DPL to the M(HL).		
	IPDR i4	Input port to AC direct	1 1 0 0 0 1 1 0	1 1 1 1 i ₃ i ₂ i ₁ i ₀	2	2	AC ← (P(i4))	Inputs the contents of port accessed by i4 to the accumulator (AC).	ZF	
	IP45	Input port 4,5 to E, AC respectively	1 1 0 0 1 1 0 1	1 1 1 1 0 1 0 0	2	2	E ← (P(4)) AC ← (P(5))	Inputs the contents of ports 4 and 5 to the E register and accumulator (AC) respectively.		
	OP	Output AC to port	0 0 1 0	0 1 0 1	1	1	P(DPL) ← (AC)	Outputs the contents of the accumulator (AC) to a port accessed by DPL.		
	OPM	Output M to port	0 0 0 1	1 0 1 0	1	1	P(DPL) ← (M(HL))	Outputs the contents of the M(HL) to a port accessed by DPL.		
	OPDR i4	Output AC to port direct	1 1 0 0 0 1 1 1	1 1 1 1 i ₃ i ₂ i ₁ i ₀	2	2	P(i4) ← (AC)	Outputs the contents of the accumulator (AC) to a port accessed by i4.		
	OP45	Output E, AC to port 4,5 respectively	1 1 0 0 1 1 0 1	1 1 1 1 0 1 0 1	2	2	P(4) ← (E) P(5) ← (AC)	Outputs the contents of the E register and accumulator (AC) to ports 4 and 5 respectively.		
	SPB t2	Set port bit	0 0 0 0	1 0 t ₁ t ₀	1	1	(P(DPL), t2) ← 1	Sets a bit specified by immediate data t1t0 of a port accessed by DPL.		
	RPB t2	Reset port bit	0 0 1 0	1 0 t ₁ t ₀	1	1	(P(DPL), t2) ← 0	Resets a bit specified by immediate data t1t0 of a port accessed by DPL.	ZF	
	ANDPDR i4, p4	AND port with immediate data then output	1 1 0 0 i ₃ i ₂ i ₁ i ₀	0 1 0 1 P ₃ P ₂ P ₁ P ₀	2	2	P(P ₃ ~P ₀) ← (P(P ₃ ~P ₀) ∨ i ₃ ~i ₀)	Performs a logical AND operation between the contents of a port specified by P3 to P0 and immediate data i3i2i1i0 and outputs the resulted product to the port.	ZF	
	ORPDR i4, p4	OR port with immediate data then output	1 1 0 0 i ₃ i ₂ i ₁ i ₀	0 1 0 0 P ₃ P ₂ P ₁ P ₀	2	2	P(P ₃ ~P ₀) ← (P(P ₃ ~P ₀) ∨ i ₃ ~i ₀)	Performs a logical OR operation between the contents of a port specified by P3 to P0 and immediate data i3i2i1i0 and outputs the resulted sum to the port.	ZF	
	Timer control instructions	WTTM0	Write timer 0	1 1 0 0	1 0 1 0	1	2	TIMER0 ← (M2(HL)), (AC)	Writes the contents of the M(HL) and the accumulator (AC) to the timer 0 reload register.	
WTTM1		Write timer 1	1 1 0 0 1 1 1 1	1 1 1 1 0 1 0 0	2	2	TIMER1 ← (E), (AC)	Writes the contents of the E register and the accumulator (AC) to the timer 1 reload register.		
RTIM0		Read timer 0	1 1 0 0	1 0 1 1	1	2	M2(HL), AC ← (TIMER0)	Reads the contents of the timer 0 counter into the M2(HL) and the accumulator (AC).		
RTIM1		Read timer 1	1 1 0 0 1 1 1 1	1 1 1 1 0 1 0 1	2	2	E, AC ← (TIMER1)	Reads the contents of the timer 1 counter into the E register and the accumulator (AC).		
START0		Start timer 0	1 1 0 0 1 1 1 0	1 1 1 1 0 1 1 0	2	2	Start timer 0 counter	Starts the timer 0 counter operation.		
START1		Start timer 1	1 1 0 0 1 1 1 0	1 1 1 1 0 1 1 1	2	2	Start timer1 counter	Starts the timer 1 counter operation.		
STOP0		Stop timer 0	1 1 0 0 1 1 1 1	1 1 1 1 0 1 1 0	2	2	Stop timer 0 counter	Stops the timer 0 counter operation.		
STOP1		Stop timer 1	1 1 0 0 1 1 1 1	1 1 1 1 0 1 1 1	2	2	Stop timer1 counter	Stops the timer 1 counter operation.		

Instruction type	Mnemonics		Instruction code		Bytes	Cycles	Function	Description	Status flags affected	Remarks
			D ₇ D ₆ D ₅ D ₄	D ₃ D ₂ D ₁ D ₀						
Interrupt control instructions	MSET	Set Interrupt Master Enable Flag	1 1 0 0 0 1 0 1	1 1 0 1 0 0 0 0	2	2	MSE-1	Sets the interrupt master enable flag.		
	MRESET	Reset Interrupt Master Enable Flag	1 1 0 0 1 0 0 1	1 1 0 1 0 0 0 0	2	2	MSE--0	Resets the interrupt master enable flag.		
	EIH i4	Enable interrupt high	1 1 0 0 0 1 0 1	1 1 0 1 i ₃ i ₂ i ₁ i ₀	2	2	EDIH-(EDIH)∨i4	Sets the interrupt enable flag.		
	EIL i4	Enable interrupt low	1 1 0 0 0 1 0 0	1 1 0 1 i ₃ i ₂ i ₁ i ₀	2	2	EDIL-(EDIL)∨i4	Sets the interrupt enable flag.		
	DIH i4	Disable interrupt high	1 1 0 0 1 0 0 1	1 1 0 1 i ₃ i ₂ i ₁ i ₀	2	2	EDIH-(EDIH)∧i4	Resets the interrupt enable flag.	ZF	
	DIL i4	Disable interrupt low	1 1 0 0 1 0 0 0	1 1 0 1 i ₃ i ₂ i ₁ i ₀	2	2	EDIL-(EDIL)∧i4	Resets the interrupt enable flag.	ZF	
	WTSP	Write SP	1 1 0 0 1 1 0 1	1 1 1 1 1 0 1 0	2	2	SP--(E), (AC)	Transfers the contents of the E register and accumulator (AC) to the stack area.		
	RSP	Read SP	1 1 0 0 1 1 0 1	1 1 1 1 1 0 1 1	2	2	E, AC--(SP)	Transfers the contents of the stack area to the E register and accumulator (AC).		
Standby control instructions	HALT	HALT	1 1 0 0 1 1 0 1	1 1 1 1 1 1 1 0	2	2	HALT	Selects the HALT mode.		
	HOLD	HOLD	1 1 0 0 1 1 0 1	1 1 1 1 1 1 1 1	2	2	HOLD	Selects the HOLD mode.		
Serial I/O control instructions	STARTS	Start serial I/O	1 1 0 0 1 1 1 0	1 1 1 1 1 1 1 0	2	2	START SIO	Starts the SIO operation mode.		
	WTSIO	Write serial I/O	1 1 0 0 1 1 1 0	1 1 1 1 1 1 1 1	2	2	SIO -(E), (AC)	Writes the contents of the E register and accumulator (AC) to the SIO register.		
	RSIO	Read serial I/O	1 1 0 0 1 1 1 1	1 1 1 1 1 1 1 1	2	2	E, AC--(SIO)	Reads the contents of the SIO register into the E register and the accumulator (AC).		
Other instructions	NOP	No operation	0 0 0 0 0 0 0 0	0 0 0 0 0 0 0 0	1	1	No operation	A dummy instruction that is coded 00H and has no effect when executed. Just one machine cycle signal reaches the CPU.		
	SB i2	Select bank	1 1 0 0 1 1 0 0	1 1 1 1 0 0 i ₁ i ₀	2	2	PC12-i ₁ i ₀	Selects memory banks.		

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